

Spec. No. JEFL243C-9121A-01 P 1/10

Wire Wound Chip Common Mode Choke Coil DLW5ATH□□□TQ2□ Murata Standard Reference Specification [AEC-Q200]

1. Scope

This reference specification applies to Wire Wound Chip Common Mode Choke Coil DLW5ATH_TQ Series for Automotive Electronics based on AEC-Q200.

2. Part Numbering

(1) Chip Common Mode Choke Coil

(2) Structure (W : Winding Type)

(3) Dimension (L×W)

(4) Type

(5) Category

(6) Impedance (Typ. at 100MHz)

(7) Circuit

(8) Features

(9) Number of Line

(10) Packaging Code L: Taping (φ180mm/reel)

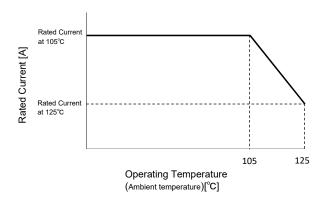
K : Taping (ϕ 330mm/reel)

B: Bulk

3. Rating

Customer	MURATA Part Number	Under Standard	Impedance at 100MHz, Under Standard Testing Conditions (ΩTyp.)	Rated Voltage V(DC)	Withstanding Voltage V(DC)	Rated Current(*)(A)		DC Resistance	Insulation	ESD
Part Number						at 105°C	at 125°C	(Rdc) (Ωmax.)	Resistance (MΩ min.)	Rank 2.2kV
	DLW5ATH450TQ2L									
	DLW5ATH450TQ2K	4.7	45			4.0	2.5	0.013		
	DLW5ATH450TQ2B									
	DLW5ATH111TQ2L									
	DLW5ATH111TQ2K 12	12	110			3.0	2.0	0.020		
	DLW5ATH111TQ2B	5ATH111TQ2B			1					
	DLW5ATH231TQ2L					2.5	1.5	0.027	10	2
	DLW5ATH231TQ2K		230	50	125					
	DLW5ATH231TQ2B									
	DLW5ATH401TQ2L									
	DLW5ATH401TQ2K	K 35	400	-		2.0 1.2	1.2	0.034	_	
	DLW5ATH401TQ2B									
	DLW5ATH501TQ2L					1.5 1.0				
	DLW5ATH501TQ2K		500				1.0	0.056		
	DLW5ATH501TQ2B									

(*)As for DLW5ATH_TQ type Rated Current is derated as following figure depending on the operating temperature.



Operating Temperature: -40 °C to + 125 °C Storage Temperature: -40 °C to + 125 °C



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4. Standard Testing Conditions

< Unless otherwise specified >

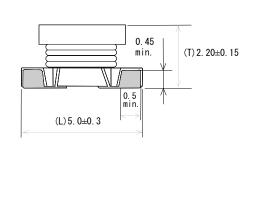
Temperature : Ordinary Temp. 15 °C to 35 °C

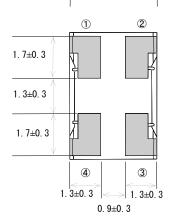
(W) 3. 6±0. 3

Humidity: Ordinary Humidity 25 %(RH) to 85 %(RH)

5. Style and Dimensions

< In case of doubt >
Temperature : 20 °C ± 2 °C
Humidity : 60 %(RH) to 70 %(RH)
Atmospheric pressure : 86 kPa to 106 kPa

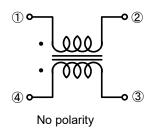






(in: mm)

■ Equivalent Circuites



■ Unit Mass (Typical value)

0.14g

6. Marking

No marking.

7. Electrical Performance

No.	Item	Specifications	Test Method
7.1	Impedance	Meet item 3.	Measuring Equipment : KEYSIGHT 4191A or the equivalents.
	(Z) (at 10MHz)		Measuring Frequency: 10MHz (ref. Item 9.)
7.2	Insulation		Measuring Equipment : R8340A or the equivalents.
	Resistance		Measuring voltage : Rated Voltage
	(I.R.)		Time: within 60 s (ref. Item 9.)
7.3	DC Resistance		Measuring Current : 100 mA max. (ref. Item 9.)
	(Rdc)		(In case of doubt in the above mentioned standard
			condition,measure by 4 terminal method.)
7.4	Withstanding	Products shall not be	Test Voltage : 2.5 times for Rated Voltage
	Voltage	damaged.	Time: 1 to 5 seconds
			Charge Current : 1 mA max. (ref. Item 9.)



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8. Q200 Requirement

7-1. Performance (based on Table 13 for Ferrite EMI SUPPRESSORS/FILTERS) AEC-Q200 Rev.D issued June 1. 2010

	A A	EC-Q200	Murata Chasification / Deviation		
No.			– Murata Specification / Deviation		
3	High	1000hours at 125 deg C	Meet Table A after testing.		
	Temperature	Set for 24hours at room temperature,	Table A		
	Exposure	then measured.	Appearance No damaged.		
			Impedance change within ± 20%		
			(at 10MHz)		
			I.R. 10MΩ min.		
			Withstanding Voltage No damaged.		
4	Temperature Cycling	1000cycles	Meet Table A after testing.		
		-40 deg C to +125 deg C			
		Set for 24hours at room temperature,			
5	Destructive	then measured. Per EIA469	Not Applicable		
3	Physical Analysis	No electrical tests	тчот друпсаше		
7	Biased Humidity	1000hours at 85 deg C, 85%RH	Meet Table A after testing.		
		Apply max rated voltage and current.	Apply rated voltage.		
	On a mation all life	Annih 105 day 0	(ref.item 9)		
8	Operational Life	Apply 125 deg C 1000hours	Meet Table A after testing. Apply derating of rated current.		
		Set for 24hours at room temperature,	Apply defailing of faled current.		
		then measured	(ref.item 9)		
9	External Visual	Visual inspection	No abnormalities		
10	Physical Dimension	Meet ITEM 5	No defects		
		(Style and Dimensions)			
12	Resistance to Solvents	Per MIL-STD-202 Method 215	Not Applicable		
	Corvonio				
13	Mechanical Shock	Per MIL-STD-202 Method 213	Meet Table A after testing.		
		Conditon F:			
		1500g's(14.7N)/0.5ms/			
14	Vibration	Half sine 5g's(0.049N) for 20 minutes, 12cycles	Most Table A after testing		
14	Vibration	each of 3 oritentations	inteet Table A after testing.		
		Test from 10-2000Hz.			
		12cycles each of 3 orientations			
15	Resistance	No-heating	Pre-heating: 150 C / 60s min.		
	to Soldering Heat	Solder temperature	Meet Table A after testing.		
		260C+/-5 deg C			
4-	F0D	Immersion time 10s	Mark Table A official C		
17	ESD	Per AEC-Q200-002	Meet Table A after testing.		
18	ESD Rank: Refer to Item 3. Rat 18 Solderbility Per J-STD-002 Method b : Not Applicable		Method b : Not Applicable		
	Coldorbinity	3.0.015-002	90% of the terminations is to be soldered.		
			(except partly-exposed wire)		
			Flux:Ethanol solution of rosin,25(wt)% includes activator		
			equivalent to 0.06 to 0.10(wt)% chlorine		
19	Electrical	Measured : Impedance	No defects		
	Characterization				

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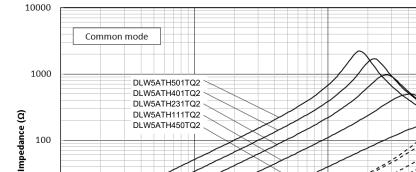
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		AEC-Q200	Murata Specification / Deviation
No.	Stress	Test Method	ividiata Specification / Deviation
20	Flammability	Per UL-94	Not Applicable
21	Board Flex	Epoxy-PCB(1.6mm) Deflection 2mm(min) 60 sec minimum holding time	Meet Table A after testing.
22	Terminal Strength	Per AEC-Q200-006 A force of 17.7N for 60sec	No defects
30	Electrical Transient Conduction	Per ISO-7637-2	Not Applicable

9. Terminal to be Tested When measuring and supplying the voltage, the following terminal is applied.

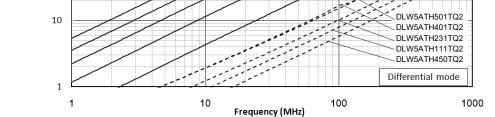
No.	Item	Terminal to be Tested
9.1	Impedance (Z)	Terminal → ♥ ↑ () () / ← ♥ ← Terminal
	(Measurement Terminal)	• • • • • • • • • • • • • • • • • • •
9.2	DC Resistance (Rdc)	·
	(Measurement Terminal)	ii
9.3	Insulation Resistance (I.R.)	Terminal ←→o—,
	(Measurement Terminal)	Terrifical • • • • • • • • • • • • • • • • • • •
9.4	Withstanding Voltage	<u>√.</u>
	(Measurement Terminal)	'
9.5	Biased Humidity (Supply Terminal)	Terminal → O
9.6	Operational Life (Supply Terminal)	<u>↓</u> ••
		'

10. Impedance Frequency Characteristics (Typical)



DLW5ATH450TQ2

DLW5ATH_TQ Series



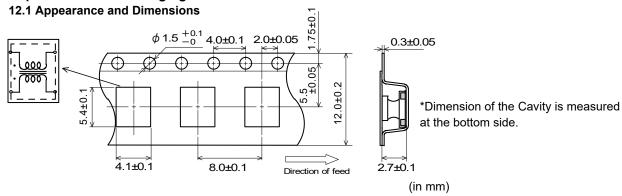
11. P.C.B., Flux, Solder and Soldering condition

100

Test shall be done using P.C.B., Flux, Solder and Soldering condition which are specified in item 14 except the case of being specified special condition.

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12. Specification of Packaging



12.2 Specification of Taping

- (1) Packing quantity (Standard quantity) ϕ 180 mm reel : 700 pcs. / reel ϕ 330 mm reel :2500 pcs. / reel
- (2) Packing Method

Products shall be packaged in each embossed cavity of plastic tape and sealed with cover tape.

(3) Sprocket Hole

The sprocket holes are to the right as the tape is pulled toward the user.

(4) Spliced point

The cover tape have no spliced point.

(5) Missing components number

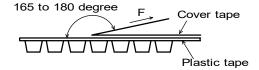
Missing components number within 0.025% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

12.3 Pull Strength of Plastic Tape

Plastic Tape	5 N min.
Cover Tape	10 N min.

12.4 Peeling off force of Cover Tape

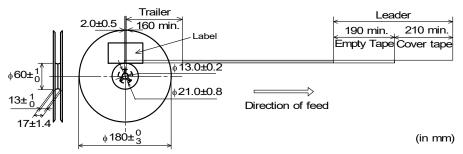
0.2N to 0.7N (minimum value is typical.) Speed of Peeling off : 300 mm / min



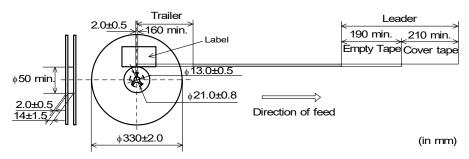
12.5 Dimensions of Leader-tape, Trailer and Reel

There shall be leader-tape (cover tape only and empty tape) and trailer-tape (empty tape) as follows.

« Packaging Code : L (\$\phi\$ 180mm reel) »



« Packaging Code : K (\$\phi\$ 330mm reel) »



Reference Only

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12.6 Marking for reel

Customer part number, MURATA part number, Inspection number(*1), RoHS marking(*2), Quantity, etc

*1) « Expression of Inspection No. » $\frac{\Box}{(1)} \frac{OOO}{(2)} \frac{\times \times}{(3)}$

(1) Factory Code (2) Date First digit : Year / Last digit of year

Second digit : Month / Jan. to Sep. \rightarrow 1 to 9, Oct. to Dec. \rightarrow O,N,D

Third, Fourth digit: Day

(3) Serial No.

*2) « Expression of RoHS marking » ROHS – \underline{Y} ($\underline{\triangle}$)

(1)(2)

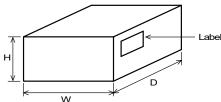
(1) RoHS regulation conformity parts.

(2) MURATĂ classification number

12.7 Marking for Outside package

Customer name Purchasing Order Number, Customer Part Number, MURATA part number, RoHS marking(*2), Quantity, etc

12.8 Specification of Outer Case



Reel	Outer Case Dimensions (mm)			Standard Reel Quantity in Outer Case	
	W	D	Н	(Reel)	
φ 180mm	186	186	93	4	
φ330mm	340	340	85	4	

* Above Outer Case size is typical. It depends on a quantity of an order.

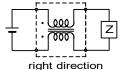
13. \triangle Caution

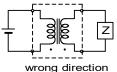
13.1 Mounting Direction

Mount products in right direction.

Wrong direction which is 90 $^{\circ}$ rotated from right direction cause not open or short circuit but also flames

or other serious trouble.





13.2 Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

(1) Aircraft equipment

(6) Transportation equipment (trains, ships, etc.)

(2) Aerospace equipment

(7) Traffic signal equipment

- (3) Undersea equipment
- (8) Disaster prevention / crime prevention equipment
- (4) Power plant control equipment
- (9) Data-processing equipment
- (5) Medical equipment

(10) Applications of similar complexity and / or reliability requirements to the applications listed in the above.

13.3 Caution(Rating)

Do not exceed maximum rated current of the product. Thermal stress may be transmitted to the product and short/open circuit of the product or falling off the product may be occurred.

13.4 Fail-safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

13.5 Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.

14. Notice

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

14.1 Flux and Solder

Flux	Use rosin-based flux,(with converting chlorine content 0.06 to 0.1(wt)%.),	
	but not highly acidic flux	
	(with Halogen content exceeding 0.2(wt)% conversion to chlorine).	
	Do not use water-soluble flux.	
Solder	Use Sn-3.0Ag-0.5Cu solder	

14.2 Assembling

< Exclusive use of Reflow soldering >

Flow soldering may cause deterioration in insulation resistance.

So,reflow soldering shall be applied for this product.

< Thermal Shock >

Pre-heating should be in such a way that the temperature difference between solder and ceramic surface is limited to 100°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

Not enough preheating may cause deterioration in insulation resistance and / or crank or ceramic body.

14.3 Cleaning Conditions

Do not clean after soldering.

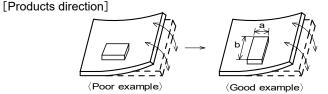
14.4 Resin coating

The impedance value may change due to high cure-stress of resin to be used for coating/molding products. An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc. Some resin contains some impurities or chloride possible to generate chlorine by hydrolysis under some operating condition may cause corrosion of wire of coil, leading to open circuit. So, please pay your careful attention when you select resin in case of coating/molding the products with the resin. Prior to use the coating resin, please make sure no reliability issue is observed by evaluating products mounted on your board.

14.5 Attention regarding P.C.B. bending

The following shall be considered when designing and laying out P.C.B.'s.

(1) P.C.B. shall be designed so that products are not subject to the mechanical stress due to warping the board.



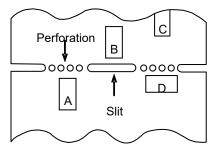
Products shall be location the sideways direction (Length:a<b) to the mechanical stress.

(2) Components location on P.C.B. separation.

It is effective to implement the following measures, to reduce stress in separating the board.

It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

Contents of Measures	Stress Level
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D*1
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface.	A > C



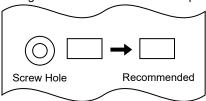
*1 A > D is valid when stress is added vertically to the perforation as with Hand Separation. If a Cutting Disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.

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(3) Mounting Components Near Screw Holes

When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw. Mount the component in a position as far away from the screw holes as possible.



14.6 Attention Regarding P.C.B. Design

- < The Arrangement of Products >
 - •P.C.B. shall be designed so that products are far from the portion of perforation.
 - •The portion of perforation shall be designed as narrow as possible, and shall be designed so as not to be applied the stress in the case of P.C.B. separation.
 - •Products shall not be arranged on the line of a series of holes when there are big holes in P.C.B.
 (Because the stress concentrate on the line of holes.)

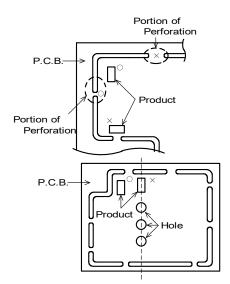
< Products Placing >

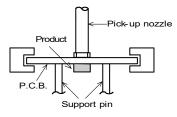
 Support pins shall be set under P.C.B. to prevent causing a warp to P.C.B. during placing the products on the other side of P.C.B..

< P.C.B. Separation >

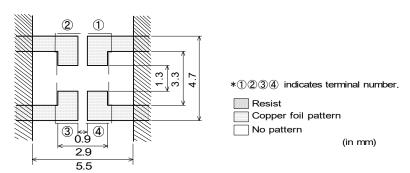
•P.C.B. shall not be separated with hand.

P.C.B. shall be separated with the fixture so as not to cause P.C.B. bending.





14.7 Standard Land Dimensions



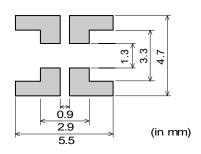
14.8 Reflow Soldering

- (1) Standard printing pattern of solder paste
 - Standard thickness of solder paste should be 150 to 200µm.

Solderability is subject to reflow condition and thermal conductivity.

Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.

- Use the solder paste printing pattern of the right pattern.
- For the resist and copper foil pattern, use standard land dimensions.
- Use the Solder Sn-3.0Ag-0.5Cu for pattern printing.

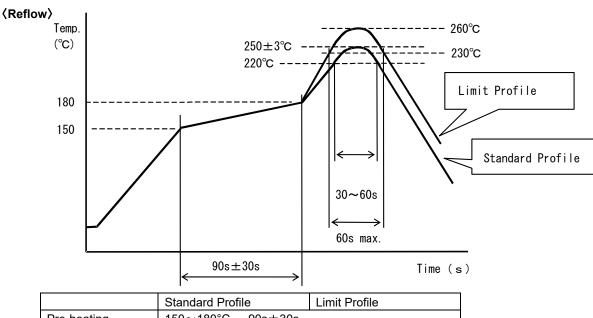


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(2) Soldering Conditions

Standard soldering profile and the limit soldering profile is as follows.

The excessive soldering conditions may cause leaching of the electrode and/or resulting in the deterioration of product quality.



Standard Profile		Limit Profile	
Pre-heating	150~180°C 、90s±30s		
Heating	above 220°C、30s∼60s	above 230°C、60s max.	
Peak temperature	250±3°C	260°C, 10s	
Cycle of reflow	2 times	2 times	

14.9 Reworking with Soldering iron

The following conditions must be strictly followed when using a soldering iron after being mounted by reflow soldering.

· Pre-heating: 150°C, 1 min · Soldering iron output: 30W max.

· Tip temperature: 350°C max. · Tip diameter: ϕ 3mm max.

Soldering time: 3(+1,-0) seconds. Times: 2times max.

Notes: Do not touch the products directly with the soldering iron.

14.10 Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.



14.11 Brushing of neighborhood of products

When you clean the neighborhood of products such as connector pins, bristles of cleaning brush shall not be touched to the winding portion to prevent the breaking of wire.

14.12 Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the performance, such as inslation resistance may result from the use.

- (1) in corrosive gases (acidic gases,alkaline gases,chlorine,sulfur gases,organic gases and etc.)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products.



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14.13 Storage condition

(1) Storage period

Use the products within 12 months after delivered.

Solderability should be checked if this period is exceeded.

(2) Storage environment conditions

· Products should be stored in the warehouse on the following conditions.

Temperature : -10 °C to +40 °C

 $\label{eq:humidity} \hbox{Humidity} \qquad \hbox{i. 15 \% to 85\% relative humidity} \qquad \hbox{No rapid change on temperature and humidity}.$

·Products should not be stored in corrosive gases, such as sulfureous, acid gases, alkaline gases,

to prevent the following deterioration.

Poor solderabirity due to the oxidized electrode.

- ·Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- ·Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- ·Avoid storing the product by itself bare (i.e.exposed directly to air).
- (3) Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

15. **A** Note

- (1)Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2)You are requested not to use our product deviating from the reference specifications.
- (3)The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

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UAL21V07012500 UAL21VR0802000 UAL24VR06500CH UALSC023000000 UALSC1020JH000 UALSC1520JH000
UALSU10VR20010 UALSU16VD30030 UALSU16VD40010 UALSU9H0305000 UALSU9HF060300 UALSU9VD070100 36-00037
5701610000 UALW21HS072450 UALSU9VD070400 UALSU9HF050500 UALSU9H0208000 UALSCF25081300 UAL24VK06450CH
PLT10HH501100PNB PLT10HH401100PNB PLT10HH1026R0PNB PE-67531 EXC-X4CH120X TLH10UB 113 0R5 2752041447
2752045447 CMS3-11-R 7351V CMF16-153131 744252510 T8116NLT FE2X10-4-2NL 744253200 744253101 744252220 TX8111NLT UAL30VR3500470 CTX01-19077-R T8003NLT